



Response Under 37 C.F.R. § 1.116 -
Expedited Procedure - Examining Group 1725

THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

NIGEL F. CLAY, ET AL

Group Art Unit: 1725

Serial No.: 10/063,300

Examiner: Len Tran

Filed: April 9, 2002

For: TIN-AND ZINC-BASED SOLDER FILLERS FOR
ALUMINUM BODY PARTS AND METHODS OF
APPLYING THE SAME

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Attorney Docket No.: FMC 1416 PUS/200-1759

AMENDMENT UNDER 37 C.F.R. § 1.116

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Sir:

In response to the final Office Action mailed June 24, 2003, please amend the
above-identified application as follows:

CERTIFICATE OF MAILING UNDER 37 C.F.R. § 1.8

I hereby certify that this paper, including all enclosures referred to herein, is being deposited with the United States Postal Service as first-class mail, postage pre-paid, in an envelope addressed to: Mail Stop AF, Commissioner for Patents, U.S. Patent & Trademark Office, P.O. Box 1450, Alexandria, VA 22313-1450 on:

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